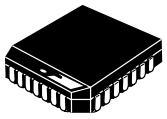
Quad 2:1 Multiplexer

MC10E157
MC100E157

QUAD 2:1
MULTIPLEXER

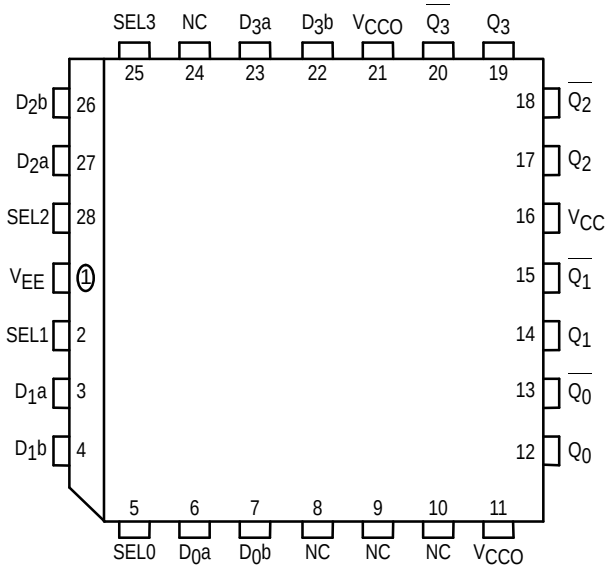
The MC10E/100E157 contains four 2:1 multiplexers with differential outputs. The output data are controlled by the individual Select (SEL) inputs. The individual select control makes the devices well suited for random logic designs.

- Individual Select Controls
- 550ps Max. D to Output
- 800ps Max. SEL to Output
- Extended 100E V_{EE} Range of – 4.2V to – 5.46V
- Internal 75kΩ Input Pulldown Resistors



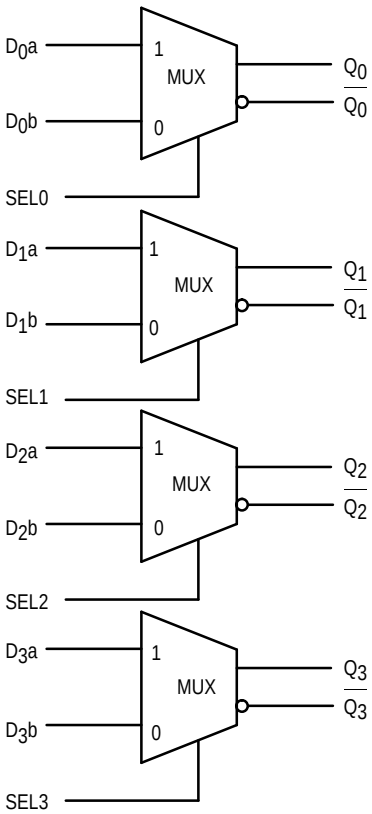
FN SUFFIX
PLASTIC PACKAGE
CASE 776-02

Pinout: 28-Lead PLCC (Top View)



* All V_{CC} and V_{CCO} pins are tied together on the die.

LOGIC DIAGRAM



PIN NAMES

Pin	Function
D_0a – D_3a	Input Data a
D_0b – D_3b	Input Data b
SEL0 – SEL3	Select Inputs
$\underline{Q_0}$ – $\underline{Q_3}$	True Outputs
Q_0 – Q_3	Inverted Outputs

TRUTH TABLE

SEL	Data
H	a
L	b

DC CHARACTERISTICS (V_{EE} = V_{EE}(min) to V_{EE}(max); V_{CC} = V_{CCO} = GND)

		0°C			25°C			85°C				
Symbol	**Characteristic**	**min**	**typ**	**max**	**min**	**typ**	**max**	**min**	**typ**	**max**	**Unit**	**Condition**
I_{IH}	Input HIGH Current										µA	
	D			200			200			200		
	SEL			150			150			150		
I_{EE}	Power Supply Current										mA	
	10E		32	38		32	38		32	38		
	100E		32	38		32	38		37	44		

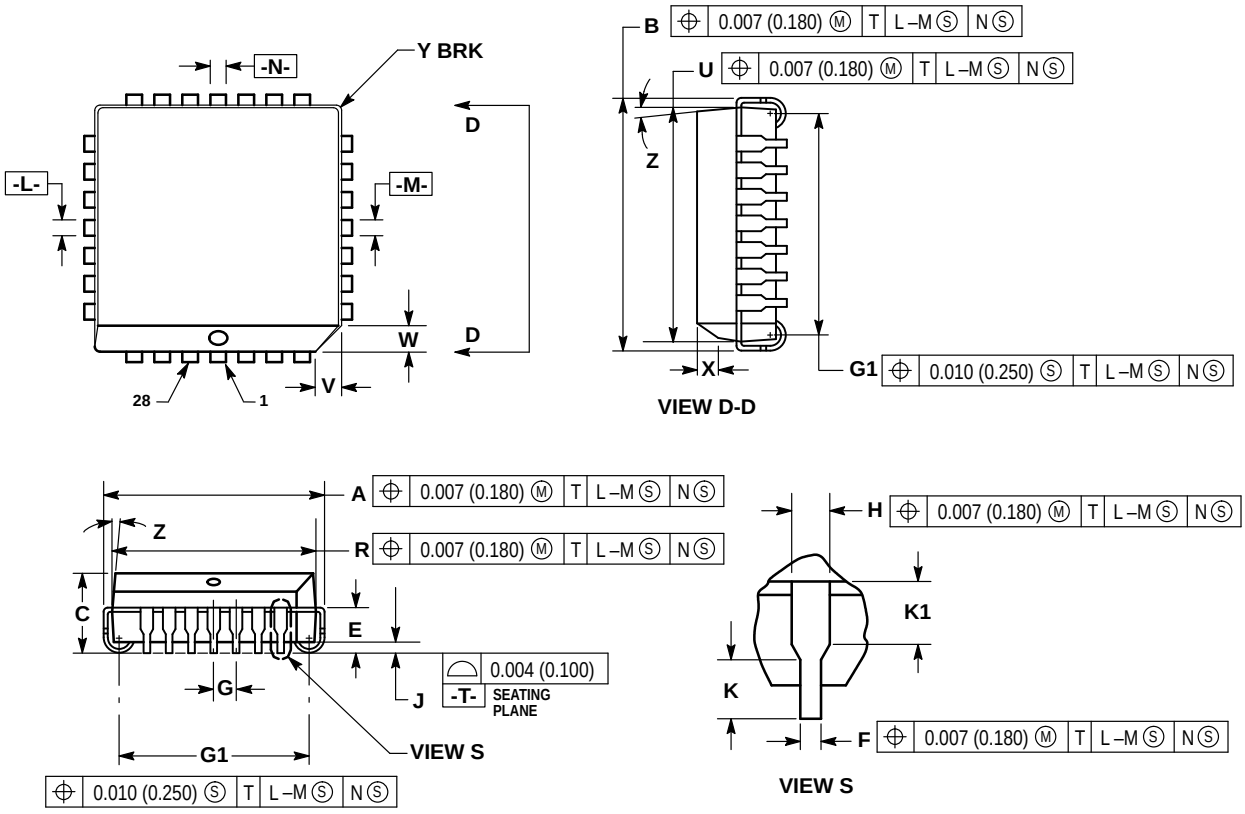
AC CHARACTERISTICS (V_{EE} = V_{EE}(min) to V_{EE}(max); V_{CC} = V_{CCO} = GND)

		0°C			25°C			85°C				
Symbol	**Characteristic**	**min**	**typ**	**max**	**min**	**typ**	**max**	**min**	**typ**	**max**	**Unit**	**Condition**
t_{PLH}	Propagation Delay to Output										ps	
t_{PHL}	D	220	380	550	220	380	550	220	380	550		
	SEL	425	600	800	425	600	800	425	600	800		
t_{SKEW}	Within-Device Skew		70			70			70		ps	1
t_r	Rise/Fall Times										ps	
t_f	20 - 80%	275	400	650	275	400	650	275	400	650		

1. Within-device skew is defined as identical transitions on similar paths through a device.

OUTLINE DIMENSIONS

FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 776–02
ISSUE D



NOTES:
1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
2. DIM G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
3. DIM R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
5. CONTROLLING DIMENSION: INCH.
6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040	—	1.02	—

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